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United States Patent [19]

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Koizumi

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[54] **CHAMBER FOR SEMICONDUCTOR FABRICATING MACHINE**

[56] **References Cited**

U.S. PATENT DOCUMENTS

[75] Inventor: **Hiroyuki Koizumi, Tokyo, Japan**

D. 326,861	6/1992	D'Amato	D15/199
3,667,589	6/1972	Constable	198/127
4,015,706	4/1977	Goffredo et al.	198/780
4,690,391	1/1987	Stoffel et al.	29/739 X
4,890,382	1/1990	Anderson et al.	29/739 X

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Attorney, Agent, or Firm—Fitzpatrick, Cella, Harper & Scinto

[**] Term: **14 Years**

[21] Appl. No.: **676,068**

[57] CLAIM

The ornamental design for a chamber for semiconductor fabricating machine, as shown and described.

[22] Filed: **Mar. 27, 1991**

DESCRIPTION

[30] Foreign Application Priority Data

Oct. 3, 1990 [JP] Japan 2-33476

[52] U.S. Cl. **D15/199**

[58] Field of Search D15/199; 29/593, 714, 29/739, 845, 848; 198/204, 127, 264, 213, 160, 37, 739, 714; 357/23.4, 49, 65, 67, 70, 71, 72; 428/620, 632, 634; 437/62, 89, 99; 148/DIG. 12; 118/50.1, 725; 219/411

FIG. 1 is a front elevational view of a chamber for semiconductor fabricating machine showing my new design;

FIG. 2 is a rear elevational view thereof;

FIG. 3 is a top plan view thereof;

FIG. 4 is a bottom plan view thereof;

FIG. 5 is a left side elevational view thereof;

FIG. 6 is a right side elevational view thereof; and,

FIG. 7 is a perspective view thereof.

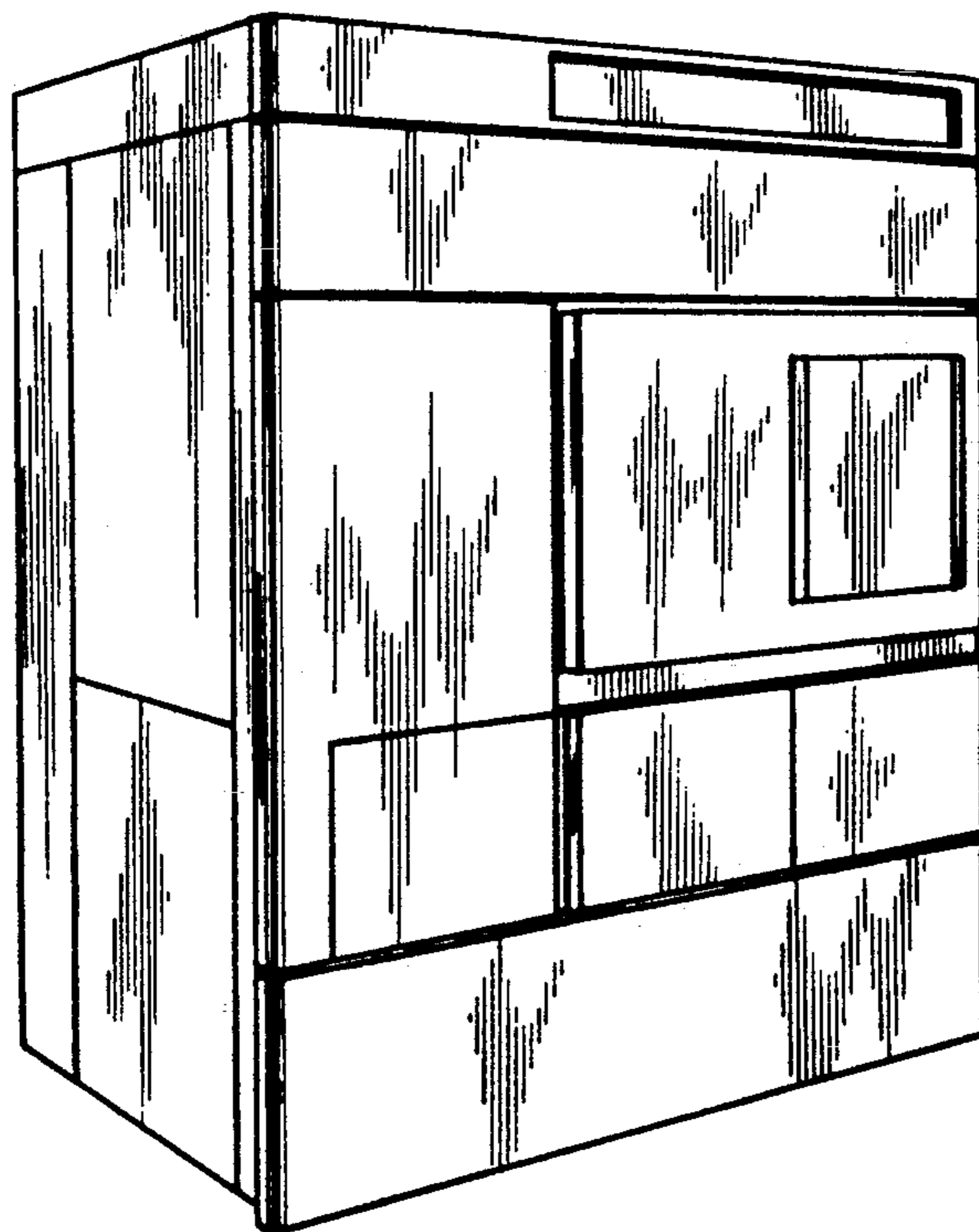


FIG. 1

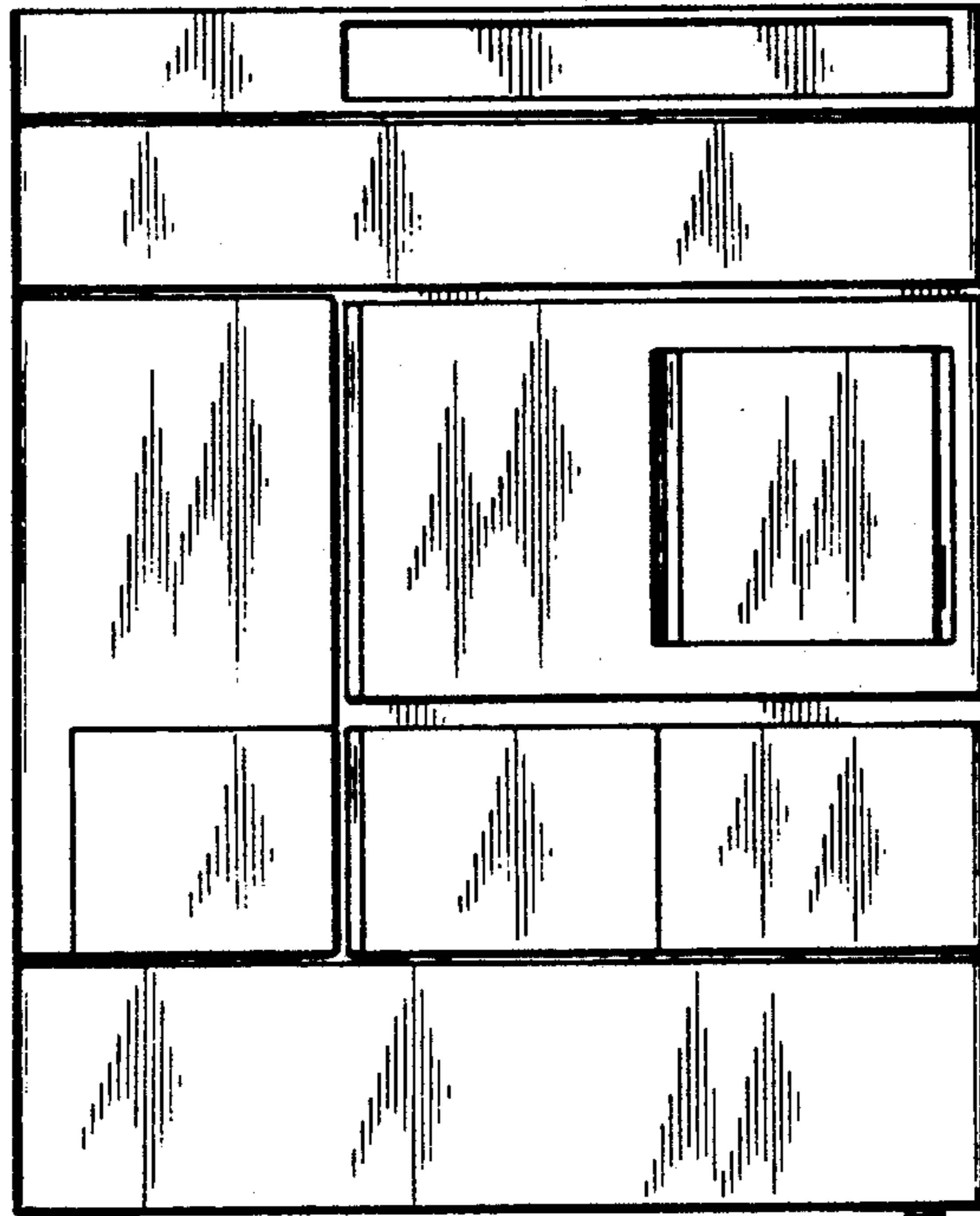


FIG. 2

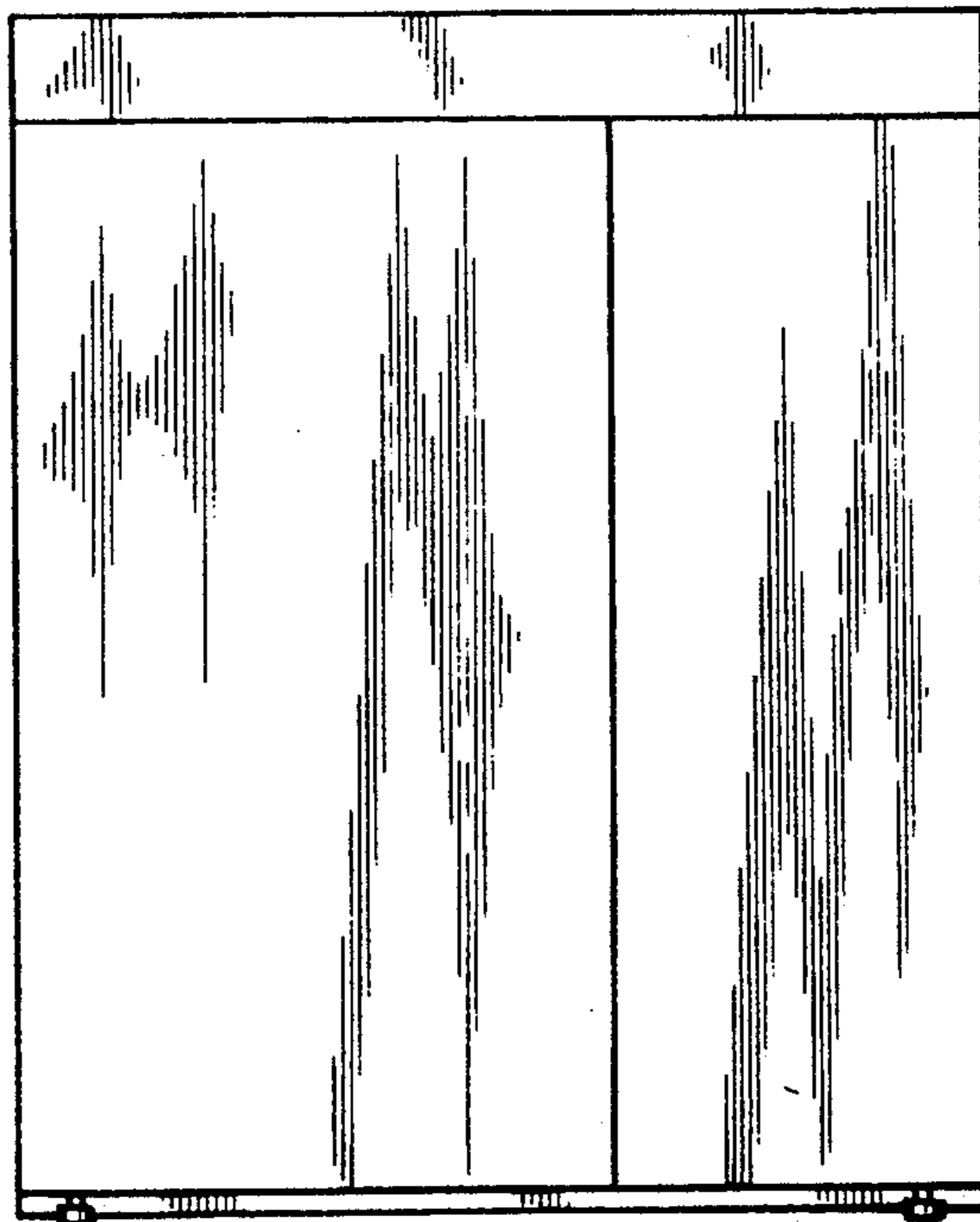


FIG. 3

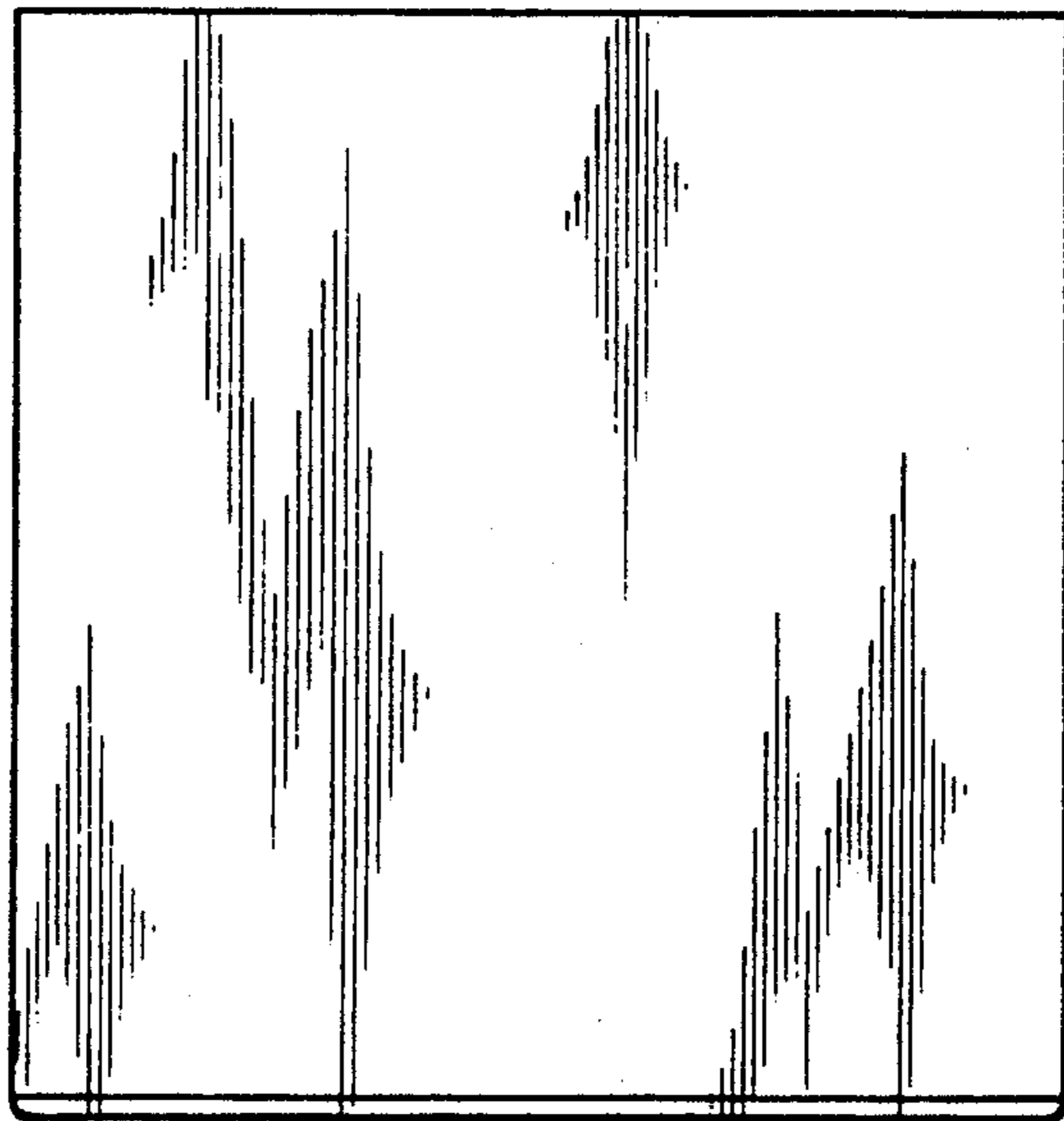


FIG. 4

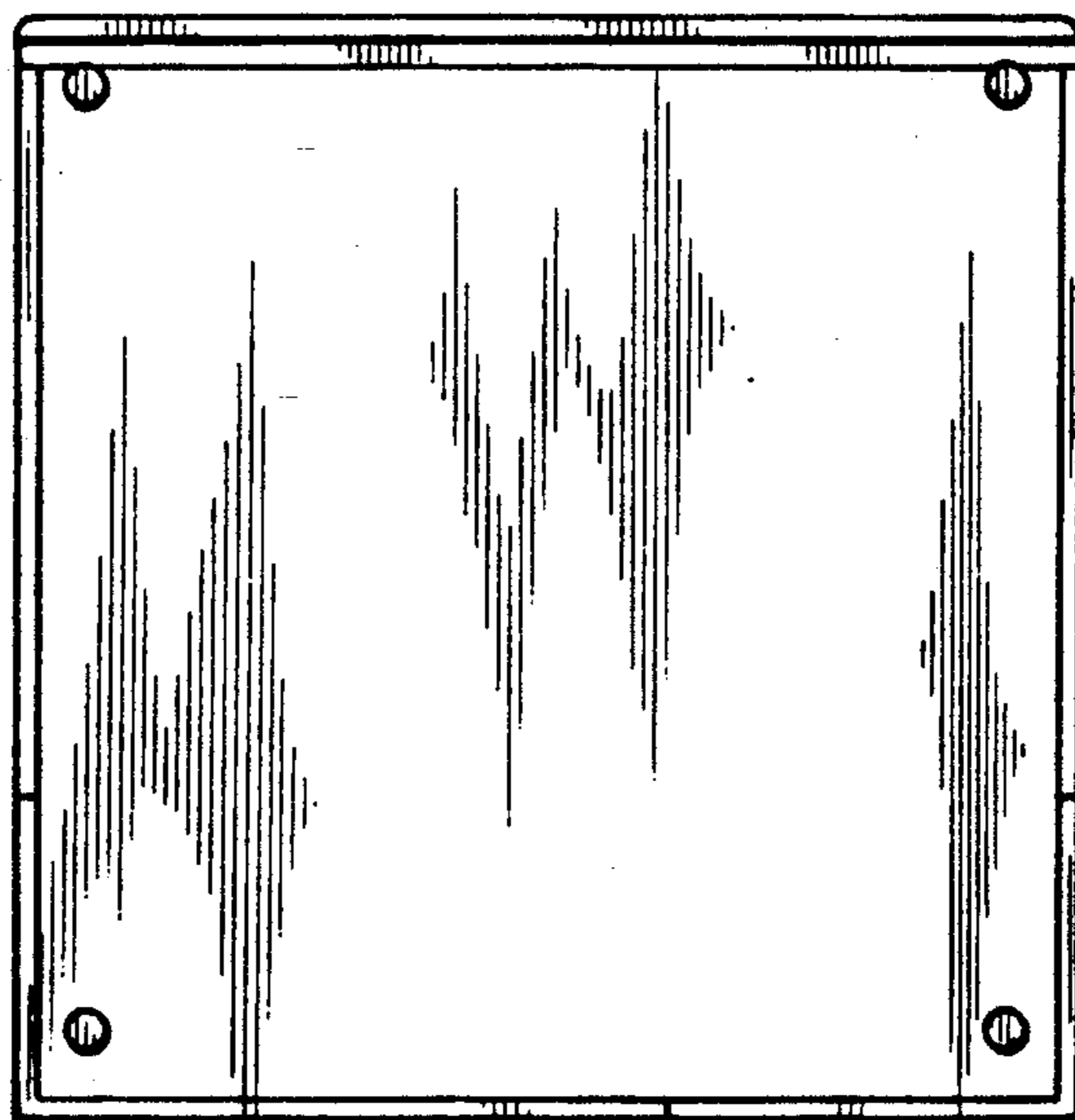


FIG. 5

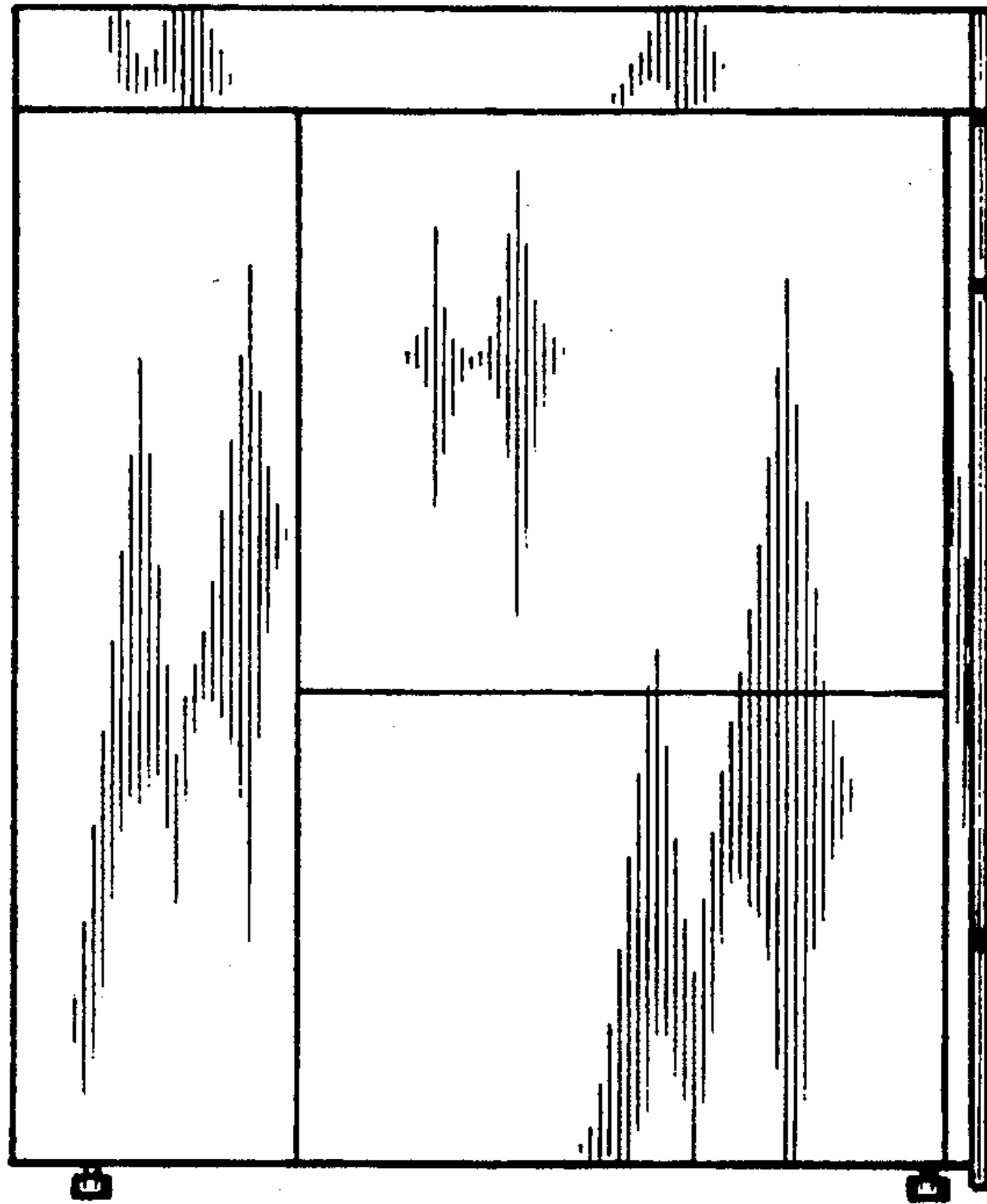


FIG. 6

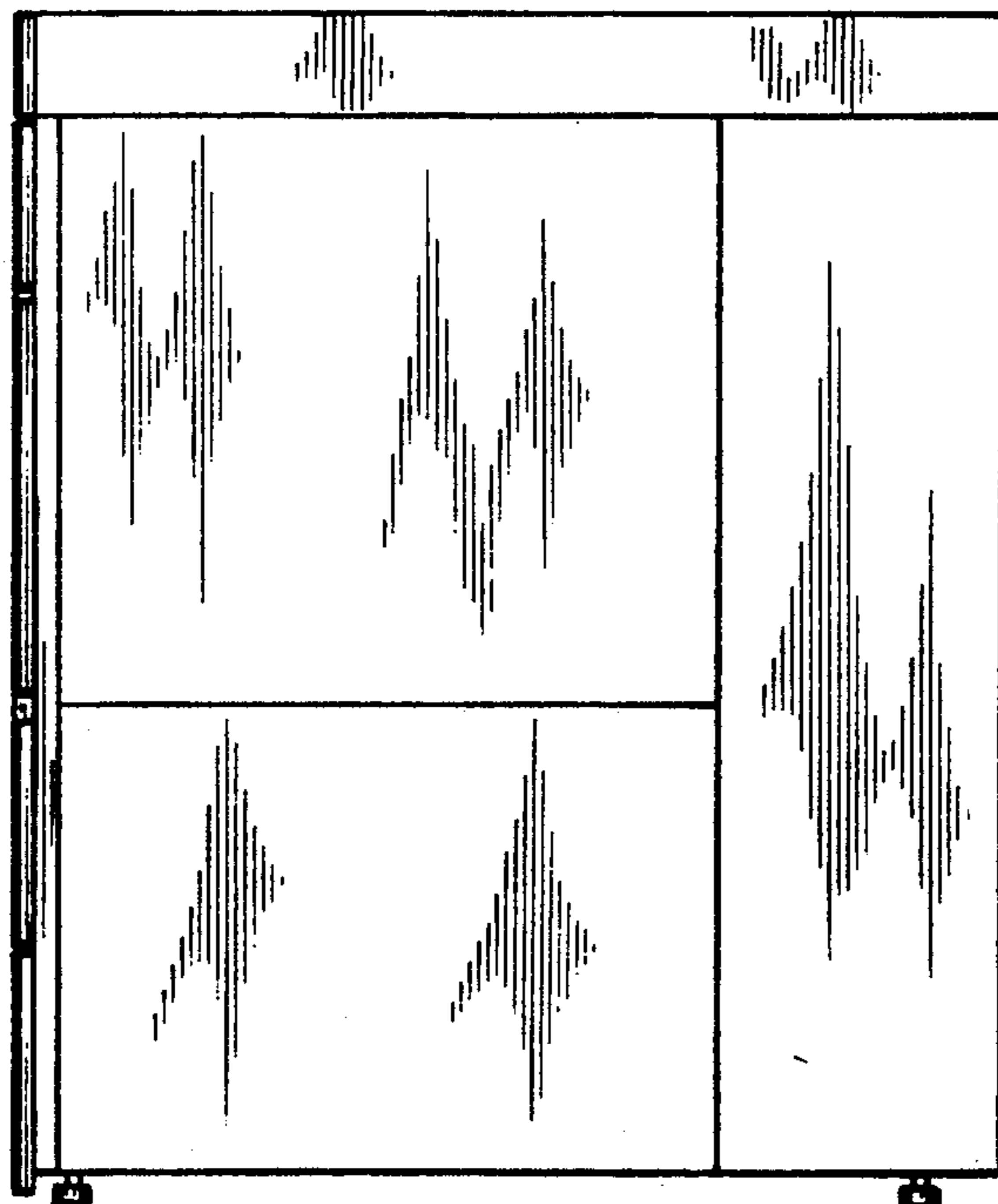


FIG. 7

